SN54ABT5402A, SN74ABT5402A 12-BIT LINE/MEMORY DRIVERS WITH 3-STATE OUTPUTS

SCBS660B - FEBRUARY 1996 - REVISED MAY 1997

- **Output Ports Have Equivalent 25-** Ω Series **Resistors, So No External Resistors Are** Required
- State-of-the-Art *EPIC*-II*B*[™] BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at V_{CC} = 5 V, T_A = 25° C
- Typical V_{OLV} (Output Undershoot) < 0.5 V at $V_{CC} = 5 V, T_A = 25^{\circ}C$
- **Package Options Include Plastic** • Small-Outline (DW) Package and Ceramic Chip Carriers (FK) and DIPs (JT)

description

These 12-bit buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output-enable (OE1 or OE2) input is high, all 12 outputs are in the high-impedance state.

The outputs, which are designed to source or sink up to 12 mA, include equivalent 25- Ω series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

| | 00 | н. | 5 | | | |
|-----------------|----------------------|--------|----------|---|----|-----|
| | D2 D1 | ٦ ۵ | 6 | | | |
| | D1 | D | 7 | | | |
| | Y1 | D | 8 | | | |
| | Y2 | þ | 9 | | | |
| | Y1 Y2 Y3 Y4 | Б | 10 | | | |
| | Y4 | Б | | | | |
| | | Γ | 11 1: | 2 | 13 | 14 |
| | | | | | | |
| | | | > | - | Υ6 | ž |
| | | | | | | 0 |
| | | | | | | |
| over the full m | | | | m | pe | rat |
| from -40°C t | o 85 | 5°(| С. | | | |

The SN54ABT5402A is characterized for operation of ture range of -55°C to 125°C. The SN74ABT5402A is characterized for operation

| | FUNCTION TABLE | | | | | | | | | | | |
|-----|----------------|--------|---|--|--|--|--|--|--|--|--|--|
| | INPUTS | OUTPUT | | | | | | | | | | |
| OE1 | OE2 | Y | | | | | | | | | | |
| L | L | L | L | | | | | | | | | |
| L | L | Н | н | | | | | | | | | |
| н | Х | Х | Z | | | | | | | | | |
| Х | Н | Х | Z | | | | | | | | | |



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| SN74ABT54 | SN54ABT5402A JT PACKAGE SN74ABT5402A DW PACKAGE (TOP VIEW) | | | | | | | | | | | | |
|-----------|--|----|------|--|--|--|--|--|--|--|--|--|--|
| Y1 [| 1 | 28 |] D1 | | | | | | | | | | |
| | 2 | 27 | D2 | | | | | | | | | | |
| | 3 | 26 | D3 | | | | | | | | | | |
| Y4 [| 4 | 25 |] D4 | | | | | | | | | | |
| Y5 [| 5 | 24 |] D5 | | | | | | | | | | |

23 D6

22 D7

20 D8

19 D9

18 D10

17 D11

16 D12

21 VCC

Y6 🛛

Y7 🛛 8

Y8 9

Y9 1 10

Y10 11

Y11 1112

Y12 13

6 GND 7

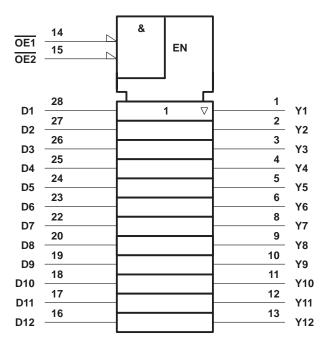
| OE1 [| 14 | 15 OE2 |
|-------|----|---------------------|
| | | FK PACKAGE VIEW) |

| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | | | (| | | | , | | | |
|--|----------------------------|--|----------|----|----|-----|----------|--|--------------------------------------|---------------------------------|
| D3 5 25 D10 D2 6 24 D11 D1 7 23 D12 Y1 8 22 OE2 Y2 9 21 OE1 Y3 10 20 Y12 Y4 11 19 Y11 12 13 14 15 16 17 18 | | D4 | D5 | D6 | D7 | Vcc | D8 | D9 | | |
| | D2 D1 Y1 Y2 Y3 | 4 5 6 7 8 9 10 11 12 | 13 13 | 14 | 15 | 16 | 27 17 | 26 22 22 22 22 22 22 21 18 | 24 [23 [22] 21 [20 [| D11 D12 OE2 OE1 Y12 |

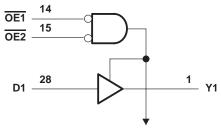
SN54ABT5402A, SN74ABT5402A 12-BIT LINE/MEMORY DRIVERS WITH 3-STATE OUTPUTS

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logic symbol[†]



logic diagram (positive logic)



To Eleven Other Channels

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the DW and JT packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

| Supply voltage range, V _{CC} | |
|---|--|
| Voltage range applied to any output in the high or power-off state, V_{O} | |
| Current into any output in the low state, I_{O} | |
| Input clamp current, I_{IK} (V _I < 0) | |
| Output clamp current, I_{OK} ($V_{O} < 0$) | |
| Package thermal impedance, θ_{JA} (see Note 2): DW package | |
| Storage temperature range, T _{stg} 65°C | |

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.



recommended operating conditions (see Note 3)

| | | | SN54ABT | 5402A | SN74AB1 | 5402A | UNIT |
|---------------------|---|-----------------|---------|-------|---------|-------|------|
| | | | MIN | MAX | MIN | MAX | UNIT |
| Vcc | Supply voltage | | 4.5 | 5.5 | 4.5 | 5.5 | V |
| VIH | High-level input voltage | 2 | EW | 2 | | V | |
| VIL | V _{IL} Low-level input voltage | | | | | 0.8 | V |
| VI | Input voltage | | 0 0 | Vcc | 0 | VCC | V |
| ЮН | High-level output current | | C, | -12 | | -12 | mA |
| IOL | Low-level output current | | 201 | 12 | | 12 | mA |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | Outputs enabled | 22 | 10 | | 10 | ns/V |
| ТА | Operating free-air temperature | | -55 | 125 | -40 | 85 | °C |

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DAD | AMETER | TEST CON | IDITIONS | Т | A = 25°C | ; | SN54ABT | 5402A | SN74ABT | 5402A | |
|--|-------------|---|--------------------------|------|----------|------|--------------|-------|---------|-------|------|
| PAR | AMEIER | TEST CON | DITIONS | MIN | TYP† | MAX | MIN | MAX | MIN | MAX | UNIT |
| VIK | | V _{CC} = 4.5 V, | I _I = -18 mA | | | -1.2 | | -1.2 | | -1.2 | V |
| | | V _{CC} = 4.5 V, | $I_{OH} = -1 \text{ mA}$ | 3.35 | 3.7 | | 3.3 | | 3.35 | | |
| Vari | | V _{CC} = 5 V, | $I_{OH} = -1 \text{ mA}$ | 3.85 | 4.2 | | 3.8 | | 3.85 | | V |
| Vон | | V _{CC} = 4.5 V | I _{OH} = -3 mA | | | | 3 | | 3.1 | | v |
| | | VCC = 4.5 V | I _{OH} = -12 mA | 2.6 | | | | | 2.6 | | |
| VOL | | V _{CC} = 4.5 V | I _{OL} = 8 mA | | | | | 0.8 | | 0.65 | V |
| VOL | | VCC = 4.5 V | I _{OL} = 12 mA | | | | | | | 0.8 | v |
| V _{hys} | | | | | 100 | | | | | | mV |
| Ц | | $V_{CC} = 5.5 V, V_{I} = V_{C}$ | CC or GND | | | ±1 | | ±1 | | ±1 | μΑ |
| IOZH | | V _{CC} = 5.5 V, | $V_{O} = 2.7 V$ | | | 10 | | 10 | | 10 | μΑ |
| IOZL | | $V_{CC} = 5.5 \text{ V}, \qquad V_{O} = 0.5 \text{ V}$ | | | | -10 | | -10 | | -10 | μΑ |
| l _{off} | | $V_{CC} = 0, \qquad \qquad V_{I} \text{ or } V_{O} \le 4.5 \text{ V}$ | | | | ±100 | 4 | 42 | | ±100 | μΑ |
| ICEX | | V _{CC} = 5.5 V, V _O = 5.5 V | Outputs high | | | 50 | UC7 | 50 | | 50 | μΑ |
| IO | | V _{CC} = 5.5 V, | V _O = 2.5 V | -25 | -45 | -100 | 25 | -100 | -25 | -100 | mA |
| los‡ | | V _{CC} = 5.5 V, | VO = 0 | -50 | | -200 | 2 –50 | -200 | -50 | -200 | mA |
| | | V _{CC} = 5.5 V, | Outputs high | | 5 | 50 | | 50 | | 50 | μA |
| ICC | | $I_{O} = 0,$ | Outputs low | | 39 | 48 | | 48 | | 48 | mA |
| | - | $V_{I} = V_{CC} \text{ or } GND$ | Outputs disabled | | 1 | 50 | | 50 | | 50 | μΑ |
| | Data inputs | V _{CC} = 5.5 V, One input at 3.4 V, | Outputs enabled | | | 1.5 | | 1.5 | | 1.5 | |
| ∆ICC§ | Data inputs | Other inputs at V _{CC} or GND | Outputs disabled | | | 0.05 | | 0.05 | | 0.05 | mA |
| Control $V_{CC} = 5.5$ V, One inputsinputsOther inputs at V_{CC} | | | | | 1.5 | | 1.5 | | 1.5 | | |
| Ci | | V _I = 2.5 V or 0.5 V | | | 3 | | | | | | pF |
| Co | | V _O = 2.5 V or 0.5 V | | | 8 | | | | | | рF |

[†] All typical values are at $V_{CC} = 5$ V.

[‡]Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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SN54ABT5402A, SN74ABT5402A **12-BIT LINE/MEMORY DRIVERS** WITH 3-STATE OUTPUTS

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} = 5 V, T _A = 25°C | | | SN54ABT5402A | | SN74ABT5402A | | UNIT |
|------------------|-----------------|----------------|---|-----|-----|--------------|-----|--------------|-----|------|
| | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| ^t PLH | D | v | 2 | 4.5 | 5.2 | 2 | 6.3 | 2 | 6.2 | ns |
| ^t PHL | D | I | 1.5 | 3.7 | 5 | 1.5 | 5.7 | 1.5 | 5.6 | 115 |
| ^t PZH | OE | v | 2.5 | 5.7 | 7.6 | 2.5 | 8.8 | 2.5 | 8.7 | 200 |
| ^t PZL | OE | Ť | 2 | 4.4 | 6.3 | 3 | 7.6 | 2 | 7.5 | ns |
| ^t PHZ | OE | V | 1.5 | 3.6 | 4.4 | 1.5 | 5.5 | 1.5 | 5.2 | |
| ^t PLZ | UE | Ϋ́ | 1.5 | 4.2 | 5.4 | 2 1.5 | 7.4 | 1.5 | 6.9 | ns |

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7 V \cap **S1** O Open **500** Ω From Output TEST **S1** $(\Lambda \Lambda)$ **Under Test** GND Open tPLH/tPHL C_L = 50 pF 7 V **500** Ω tPLZ/tPZL (see Note A) Open tPHZ/tPZH LOAD CIRCUIT 3 V **Timing Input** 1.5 V 0 V t_{su} th 3 V **Data Input** 1.5 V 1.5 V 0 V **VOLTAGE WAVEFORMS** SETUP AND HOLD TIMES 3 V 3 V Output 1.5 V 1.5 V Input 1.5 V 1.5 V Control 0 V 0 V ^tPZL - tPHL ^tPLH Output ^tPLZ VOH 3.5 V Waveform 1 1.5 V 1.5 V 1.5 V Output S1 at 7 V V_{OL} + 0.3 V VOL VOL (see Note B) ^tPHZ ^tPLH tPHL -^tPZH Output ٧он ٧он Waveform 2 V_{OH} – 0.3 V 1.5 V 1.5 V 1.5 V Output S1 at Open ≈ 0 V VOL (see Note B) **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES ENABLE AND DISABLE TIMES** INVERTING AND NONINVERTING OUTPUTS LOW- AND HIGH-LEVEL ENABLING

PARAMETER MEASUREMENT INFORMATION

NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_Q = 50 Ω, t_f ≤ 2.5 ns. t_f ≤ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|-------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| SN74ABT5402ADW | ACTIVE | SOIC | DW | 28 | 20 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT5402ADWE4 | ACTIVE | SOIC | DW | 28 | 20 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT5402ADWG4 | ACTIVE | SOIC | DW | 28 | 20 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT5402ADWR | ACTIVE | SOIC | DW | 28 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT5402ADWRE4 | ACTIVE | SOIC | DW | 28 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT5402ADWRG4 | ACTIVE | SOIC | DW | 28 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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P1

(mm)

16.0

w

(mm)

32.0

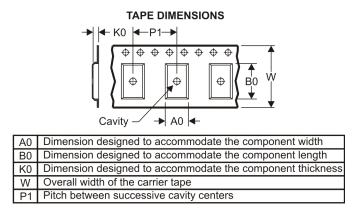
Pin1

Quadrant

Q1

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| 1 | *All dimensions are nominal | | | | | | | | | |
|---|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|
| | Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) |
| | SN74ABT5402ADWR | SOIC | DW | 28 | 1000 | 330.0 | 32.4 | 11.35 | 18.67 | 3.1 |



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ABT5402ADWR | SOIC | DW | 28 | 1000 | 346.0 | 346.0 | 49.0 |

DW (R-PDSO-G28)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AE.



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